502101156 10/19/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Samuel Waising Tam	07/19/2012
Wai Wai (David) Pun	09/22/2012
Tak Shing (Dick) Pang	07/23/2012

RECEIVING PARTY DATA

Name:	Flextronics International USA, Inc.	
Street Address:	847 Gibraltar Drive	
City:	Milpitas	
State/Country:	CALIFORNIA	
Postal Code:	95035	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13540840	

CORRESPONDENCE DATA

Fax Number: 3038630223

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 303-863-9700

Email: aduarte@sheridanross.com

Correspondent Name: Sheridan Ross P.C.

Address Line 1: 1560 Broadway

Address Line 2: Suite 1200

Address Line 4: Denver, COLORADO 80202

ATTORNEY DOCKET NUMBER:	6583-139
NAME OF SUBMITTER:	Richard E. Zelenka

Total Attachments: 2

source=6583-139_Executed_Assignment#page1.tif source=6583-139_Executed_Assignment#page2.tif

PATENT REEL: 029161 FRAME: 0298 H \$40,00 135408.

Atty. Docket No.: 6583-139

Worldwide Assignment

WHEREAS, I/We, Samuel Waising Tam, Tai Wai (David) Pun, and Tak Shing (Dick) Pang, have made an invention entitled SOLAR CELL MODULE ON MOLDED LEAD-FRAME AND METHOD OF MANUFACTURE for which I/We have filed an application for Letters Patent of the United States on July 3, 2012, under Application No. 13/540,840, and

WHEREAS, Flextronics International USA, Inc. ("ASSIGNEE"), a corporation or other business entity duly registered in the State of <u>California</u>, whose postal address is <u>847 Gibraltar Drive</u>, <u>Milpitas</u>, <u>California</u>, <u>95035</u>, desires to acquire the entire right, title, and interest in and to the invention, the application, and any Letters Patent to be granted for the invention in the United States and in all foreign countries;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) paid to me/us by ASSIGNEE, and other good and valuable consideration, the receipt and sufficiency of which I/We acknowledge, I/We, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest in and to the invention, the application, all applications claiming benefit of the application, including, but not limited to, all divisions and continuations of the application, and all Letters Patent that may be granted thereon in the United States, Canada and in all foreign countries, and all reissues thereof, together with the right to claim priority under the International Convention in all member countries; and I/We authorize and request the Director of Patents and Trademarks to issue all Letters Patent for the invention to ASSIGNEE, its successors, legal representatives, and assigns in accordance with the terms of this Assignment;

AND I/We covenant and agree that I/We have the full right to convey the entire right, title, and interest herein assigned and that I/We have not executed and will not execute any assignment or other instrument in conflict with this Assignment;

AND I/We further covenant and agree that upon request by ASSIGNEE, its successors, legal representatives, and/or assigns, and without further consideration, I/We will do all lawful acts that may be necessary or desirable to assist ASSIGNEE, its successors, legal representatives, and/or assigns to obtain and enforce patent protection for the invention in the United States and in all foreign countries, including, but not limited to, communicate with ASSIGNEE, its successors, legal representatives, and/or assigns any facts known to me/us regarding the invention, testify in any legal proceeding, sign all lawful papers, execute and deliver all papers that may be necessary or desirable to perfect the title to the invention in ASSIGNEE, its successors, legal representatives, and/or assigns, execute all divisional, continuation, and reissue applications, and make all rightful oaths, it being understood that any expense incident to the rendering of such assistance will be borne by ASSIGNEE, its successors, legal representatives, and/or assigns;

AND I/We further hereby authorize ASSIGNEE, or its attorneys or agents, to insert the correct Application Number and filing Date into this Assignment, if none is indicated on that date of my/our execution of this agreement.

IN WITNESS WHEREOF, I/We have executed this Assignment on the date(s) indicated below.

Signature:		Signature:	pur Tai wai
Date: / _ Full Name:	7/19//2012 Samuel Waising Tam	Date: Full Name:	Tai Wai (David) Pun
Address:	102 Ashland Drive	Address:	Room 2, 21/F, Block K
	Daly City, CA 94015		Sunshine City, Ma On Shan
	U.S.A.		New Territories, Hong Kong

Atty. Docket No.: 6583-139

Signature:

Date:

Full Name: Tak Shing (Dick) Pang

Address:

Room G, 3/F, Block 9

Riviera Garden, Tsuen Wan

New Territories, Hong Kong